# International Rectifier

# IRF7811WPbF

### **HEXFET® Power MOSFET for DC-DC Converters**

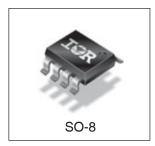
- N-Channel Application-Specific MOSFETs
- Ideal for CPU Core DC-DC Converters
- Low Conduction Losses
- · Low Switching Losses
- 100% Tested for Rg
- · Lead-Free

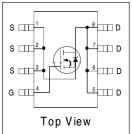
### Description

This new device employs advanced HEXFET Power MOSFET technology to achieve an unprecedented balance of on-resistance and gate charge. The reduced conduction and switching losses make it ideal for high efficiency DC-DC converters that power the latest generation of microprocessors.

The IRF7811WPbF has been optimized for all parameters that are critical in synchronous buck converters including  $R_{DS(on)}$ , gate charge and Cdv/dt-induced turn-on immunity. The IRF7811WPbF offers particularly low  $R_{DS(on)}$  and high Cdv/dt immunity for synchronous FET applications.

The package is designed for vapor phase, infra-red, convection, or wave soldering techniques. Power dissipation of greater than 3W is possible in a typical PCB mount application.





### **DEVICE CHARACTERISTICS** ⑤

	IRF7811WPbF					
$R_{DS(on)}$	$9.0 \mathrm{m}\Omega$					
$Q_{G}$	22nC					
Q <sub>sw</sub>	10.1nC					
Q <sub>oss</sub>	12nC					

### Absolute Maximum Ratings

Absolute Maximum natings				
Parameter		Symbol	IRF7811WPbF	Units
Drain-Source Voltage		V <sub>DS</sub>	30	V
Gate-Source Voltage		V <sub>GS</sub>	±12	
Continuous Drain or Source	T <sub>A</sub> = 25°C	I <sub>D</sub>	14	
Current (V <sub>GS</sub> ≥ 4.5V)	T <sub>L</sub> = 90°C		13	A
Pulsed Drain Current①		I <sub>DM</sub>	109	
Power Dissipation	T <sub>A</sub> = 25°C	P <sub>D</sub>	3.1	W
	T <sub>L</sub> = 90°C		3.0	
Junction & Storage Temperate	ure Range	$T_{J},T_{STG}$	-55 to 150	°C
Continuous Source Current (E	Body Diode)	Is	3.8	А
Pulsed Source Current①		I <sub>SM</sub>	109	

### **Thermal Resistance**

Parameter		Max.	Units
Maximum Junction-to-Ambient®	$R_{_{ heta\mathsf{JA}}}$	40	°C/W
Maximum Junction-to-Lead	R <sub>eJL</sub>	20	°C/W

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### **Electrical Characteristics**

Parameter		Min	Тур	Max	Units	Conditions
Drain-to-Source Breakdown Voltage	BV <sub>DSS</sub>	30	-	-	V	$V_{GS} = 0V$ , $I_D = 250\mu A$
Static Drain-Source on Resistance	R <sub>DS(on)</sub>		9.0	12	m $Ω$	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 15A②
Gate Threshold Voltage	$V_{GS(th)}$	1.0			V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
Drain-Source Leakage	IDSS			30		$V_{DS} = 24V, V_{GS} = 0$
Current				150	μΑ	$V_{DS} = 24V, V_{GS} = 0,$
						Tj = 100°C
Gate-Source Leakage Current	I <sub>GSS</sub>			±100	nA	$V_{GS} = \pm 12V$
Total Gate Chg Cont FET	$Q_{G}$		22	33		$V_{gs}=5.0V, I_{D}=15A, V_{DS}=16V$
Total Gate Chg Sync FET	$Q_{_{\rm G}}$		16.3			V <sub>GS</sub> = 5V, V <sub>DS</sub> < 100mV
Pre-Vth Gate-Source Charge	Q <sub>GS1</sub>		3.5			$V_{DS} = 16V, I_{D} = 15A, V_{GS} = 5.0V$
Post-Vth Gate-Source Charge	Q <sub>GS2</sub>		1.2		nC	
Gate to Drain Charge	$Q_{GD}$		8.8			
Switch Chg( $Q_{gs2} + Q_{gd}$ )	Q <sub>sw</sub>		10.1			
Output Charge	Q <sub>oss</sub>		12			$V_{DS} = 16V, V_{GS} = 0$
Gate Resistance	$R_{G}$		2.0	4.0	Ω	
Turn-on Delay Time	t <sub>d (on)</sub>		11			$V_{DD} = 16V, I_{D} = 15A$
Rise Time	t <sub>r</sub>		11		ns	$V_{GS} = 5.0V$
Turn-off Delay Time	t <sub>d (off)</sub>		29			Clamped Inductive Load
Fall Time	t,		9.9			
Input Capacitance	C <sub>iss</sub>	_	2335	_		
Output Capacitance	C <sub>oss</sub>	_	400	_	pF	$V_{DS} = 16V, V_{GS} = 0$
Reverse Transfer Capacitance	e C <sub>rss</sub>	_	119	_		

### **Source-Drain Rating & Characteristics**

Parameter		Min	Тур	Max	Units	Conditions
Diode Forward Voltage*	V <sub>SD</sub>			1.25	V	$I_{S} = 15A@, V_{GS} = 0V$
Reverse Recovery Charge ®	Q <sub>rr</sub>		45		nC	di/dt ~ 700A/ $\mu$ s $V_{DS} = 16V$ , $V_{GS} = 0V$ , $I_{S} = 15A$
Reverse Recovery Charge (with Parallel Schottky) (9	Q <sub>rr(s)</sub>		41		nC	di/dt = $700A/\mu s$ (with 10BQ040) $V_{DS} = 16V$ , $V_{GS} = 0V$ , $I_{S} = 15A$

- Notes:

  □ Repetitive rating; pulse width limited by max. junction temperature.

  □ Pulse width ≤ 400 µs; duty cycle ≤ 2%.

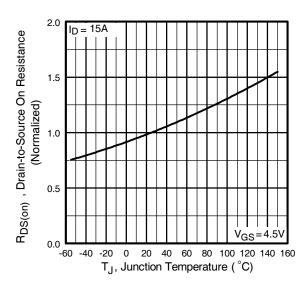
  □ When mounted on 1 inch square copper board

  □ Typ = measured Qoss

  □ Typical values of RDs(on) measured at VGs = 4.5V, QG, QSW and QOSS measured at VGS = 5.0V, VGS = 15A.

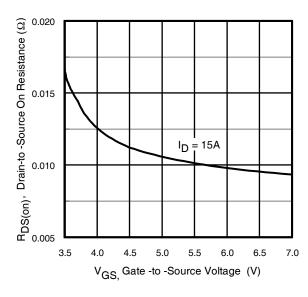
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**Fig 1.** Normalized On-Resistance Vs. Temperature

**Fig 2.** Typical Gate Charge Vs. Gate-to-Source Voltage



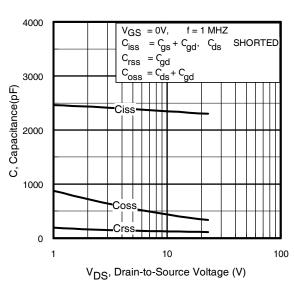
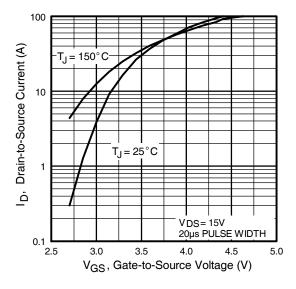


Fig 3. On-Resistance Vs. Gate Voltage

**Fig 4.** Typical Capacitance Vs. Drain-to-Source Voltage

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T<sub>J</sub> = 150°C

T<sub>J</sub> = 150°C

T<sub>J</sub> = 25°C

T<sub>J</sub> = 25°C

V<sub>SD</sub> ,Source-to-Drain Voltage (V)

Fig 5. Typical Transfer Characteristics

**Fig 6.** Typical Source-Drain Diode Forward Voltage

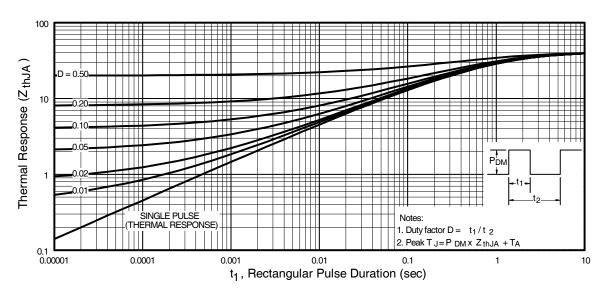
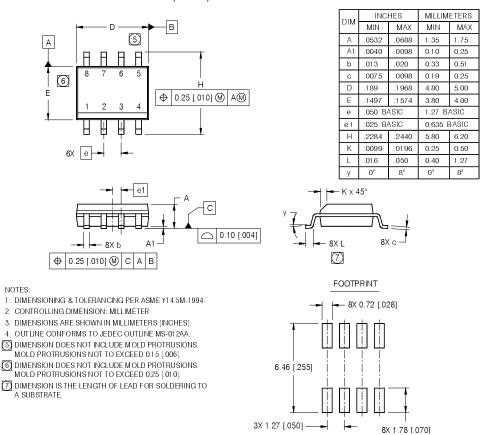


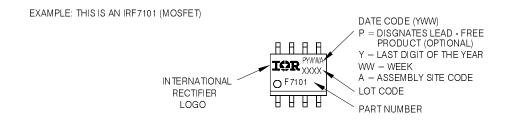
Figure 7. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

# SO-8 Package Outline(Mosfet & Fetky)

Dimensions are shown in milimeters (inches)



# SO-8 Part Marking Information



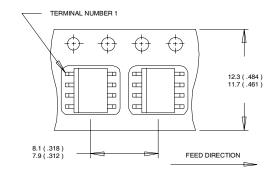
Note: For the most current drawing please refer to IR website at: <a href="http://www.irf.com/package/">http://www.irf.com/package/</a> WWW.irf.com

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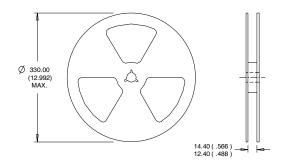
## **SO-8 Tape and Reel**

Dimensions are shown in millimeters (inches)



### NOTES:

- CONTROLLING DIMENSION : MILLIMETER.
   ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



- NOTES:
  1. CONTROLLING DIMENSION: MILLIMETER.
  2. OUTLINE CONFORMS TO EIA-481 & EIA-541.
- Note: For the most current drawing please refer to IR website at: <a href="http://www.irf.com/package/">http://www.irf.com/package/</a>

Data and specifications subject to change without notice. This product has been designed and qualified for the Consumer market. Qualification Standards can be found on IR's Web site.



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